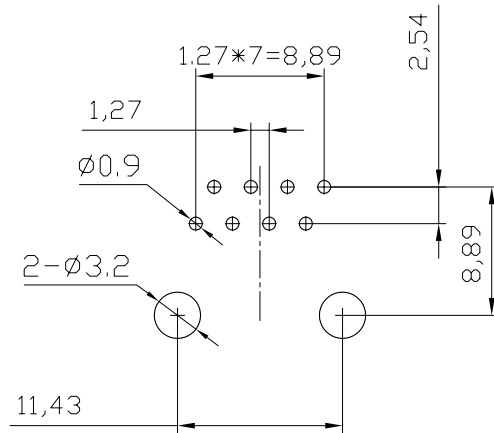
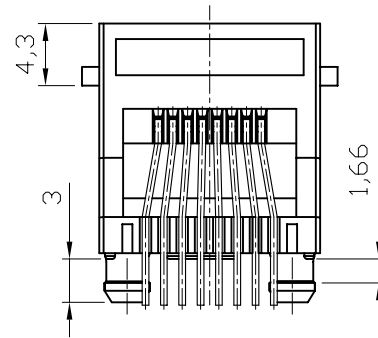
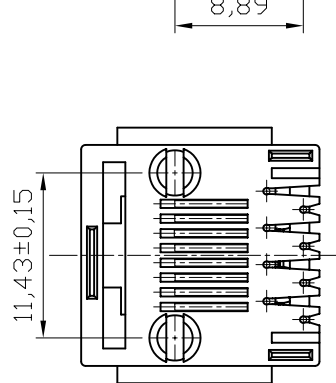
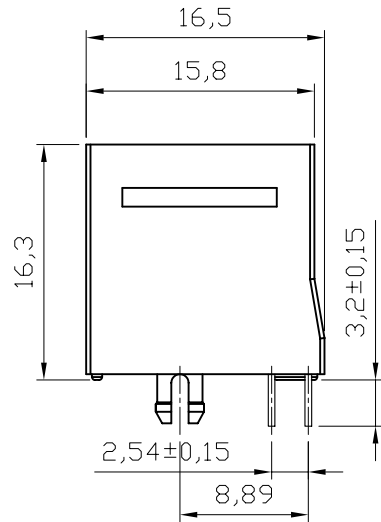
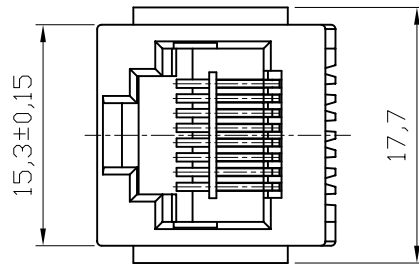


REVISION RECORD				
REV	ECD	DESCRIPTION	DRFT	CHKD



PC Board Layout
Component Side Shown

NOTES:

MATERIAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE $\varnothing=0.46\text{mm}$.
3. PLATING : GOLD PLATING $3\mu\sim 50\mu$ OVER NICKEL

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

1. DURRABILITY: : 750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO 85°C .
2. OPERATION : 0°C TO 70°C .

DETACHED LISTS	MM (INCH)		DFTO: SHB	DATE: 2007.05.0	Coorle Technology
	TOLERANCES EXCEPT AS NOTED		CHKD: LANBO	DATE: 5	
	MM		MFO:	DATE:	
	.0 ± 0.15	±	APPLV:	DATE:	
.00 ± 0.075	±	MATERIAL :		TITLE	
.000 ± 0.05	±	QTY :		52 TOP ENYRY JACK 8P8C	
ANGLES ± 0.5		FINISH :		DRAWING NO.	SIZE REV
THIRD ANGLE PROJECTION		SCALE :		/PART NO.	A3 0
DO NOT SCALE DRAWING				SHEET	OF